## **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)TYP</sub>	l <sub>D</sub>
200V	16mΩ@10V	75A



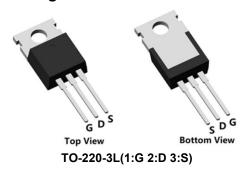
#### **Feature**

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

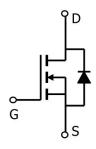
## **Applications**

- Power switching application
- DC-DC Converter
- Power Management

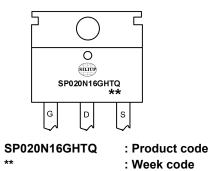
### **Package**



## Circuit diagram



### Marking



### **Order Information**

Device	Package	Unit/Tube
SP020N16GHTQ	TO-220-3L	50

## 200V N-Channel Power MOSFET

## Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	200	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current (Tc=25°C)	I <sub>D</sub>	75	Α
Continuous Drain Current (Tc=100°ℂ)	I <sub>D</sub>	50	Α
Pulsed Drain Current	I <sub>DM</sub>	300	Α
Single Pulse Avalanche Energy <sup>1</sup>	Eas	900	mJ
Power Dissipation (Tc=25°C)	P <sub>D</sub>	320	W
Thermal Resistance Junction-to-Case	R <sub>θJC</sub>	0.39	°C/W
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	$^{\circ}$
Operating Junction Temperature Range	TJ	-55 to 150	$^{\circ}$

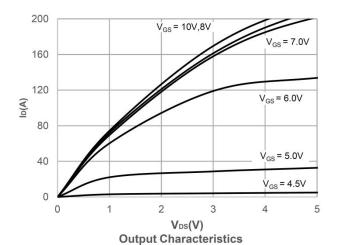
## Electrical characteristics (Ta=25°C, unless otherwise noted)

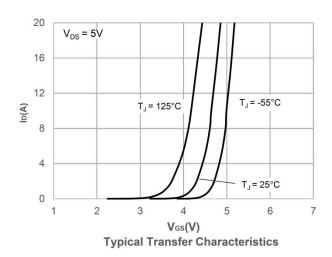
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	VGS=0V , ID=250uA	200	-	-	V
Drain Cut-Off Current	IDSS	VDS=160V , VGS=0V , TJ=25℃	-	-	1	uA
Gate Leakage Current	I <sub>GSS</sub>	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	VGS=VDS , ID =250uA	2	3	4	V
Drain-Source ON Resistance	R <sub>DS(ON)</sub>	VGS=10V , ID=20A	-	16	22.5	mΩ
Dynamic Characteristics	·				•	
Input Capacitance	Ciss	VDS=100V , VGS=0V , f=1MHz	-	5632	-	
Output Capacitance	Coss		-	211	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	1		15	-	1
Total Gate Charge	Qg	VDS=100V , VGS=10V , ID=35A	-	78	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	31	-	
Gate-Drain Charge	Q <sub>gd</sub>	1		17	-	
Switching Characteristics						
Turn-On Delay Time	t <sub>d(on)</sub>		-	45	-	
Rise Time	tr	VDD=100V, VGS=10V , RG=10Ω, ID=35A	-	46	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	79	-	nS
Fall Time	t <sub>f</sub>	1		19	-	1
Drain-Source Body Diode Characteri	stics					
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	VGS=0V , IS=1A , TJ=25℃	-	-	1.2	V
Maximum Body-Diode Continuous Current	Is		-	-	75	Α
Reverse Recovery Time	Trr	I <sub>s</sub> =35A, di/dt=100A/us, TJ=25℃		136	-	nS
Reverse Recovery Charge	Qrr			421	-	nC

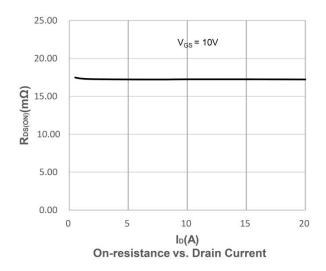
#### Note:

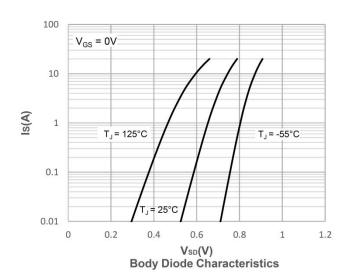
The EAS test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25 $\Omega$ 

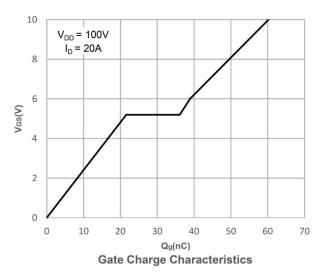
### **Typical Characteristics**

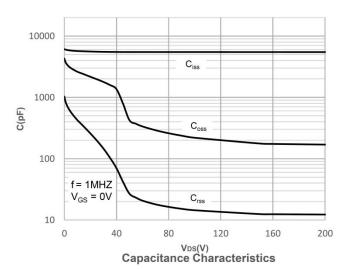




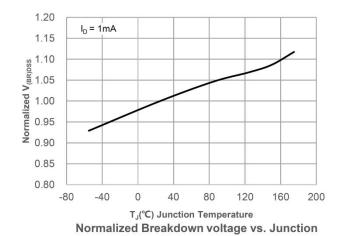




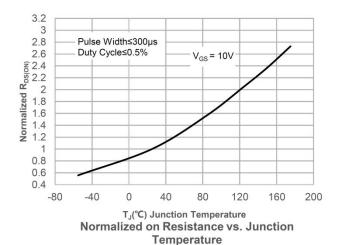


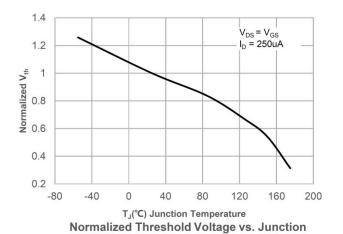




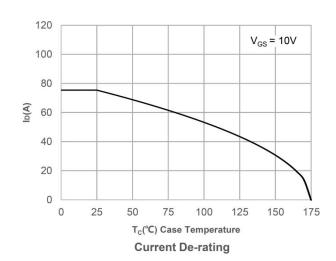


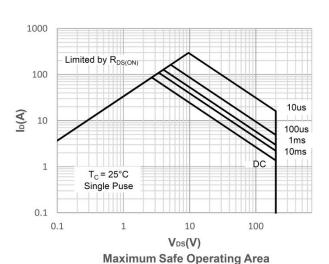
**Temperature** 

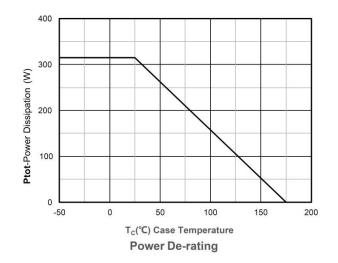




**Temperature** 

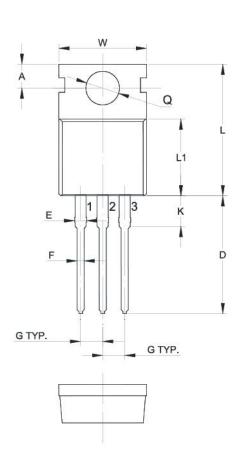


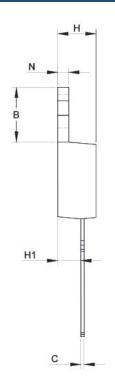


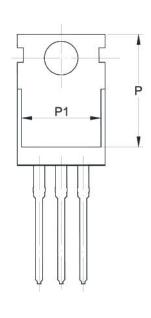


# 200V N-Channel Power MOSFET

## TO-220-3L Package Information







Symbol	Dimensions In Millimeters		
Symbol	Min.	Max.	
A	2.700	2.900	
В	6.400	6.800	
С	0.300	0.700	
D	11	15	
E	1.1	1.5	
F	0.7	0.9	
G	2.54TYP		
W	9.8	10.2	
Н	4.3	4.7	
H1	2.2	2.5	
К	2.7	3.1	
L	14.8	16.8	
L1	9.0	9.4	
N	1.2	1.4	
Р	12.7 13.3		
P1	7.6	8.2	
Q	3.5	3.7	